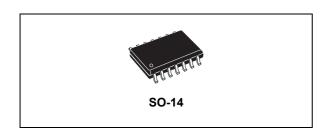


High voltage high and low-side driver

Datasheet - production data



Features

- High voltage rail up to 600 V
- dV/dt immunity ± 50 V/nsec in full temperature range
- Driver current capability
 - 400 mA source
 - 650 mA sink
- Switching times 50/30 nsec rise/fall with 1 nF load
- CMOS/TTL Schmitt trigger inputs with hysteresis and pull-down
- Undervoltage lockout on lower and upper driving section
- Integrated bootstrap diode
- · Outputs in phase with inputs

Applications

- Home appliances
- Induction heating
- Industrial applications and drives
- Motor drivers
 - SR motors.
 - DC, AC, PMDC and PMAC motors
- Asymmetrical half-bridge topologies
- HVAC
- Lighting applications
- Factory automation
- Power supply systems

Description

The L6386AD is a high voltage gate driver, manufactured with the BCD ™ "offline" technology, and able to drive simultaneously one high and one low-side power MOSFET or IGBT device. The high-side (floating) section is able to work with voltage rail up to 600 V. Both device outputs can independently sink and source 650 mA and 400 mA respectively and can be simultaneously driven high in order to drive asymmetrical half-bridge configurations.

The L6386AD device provides two input pins, two output pins and an enable pin (SD), and guarantees the outputs switch in phase with inputs. The logic inputs are CMOS/TTL compatible to ease the interfacing with controlling devices.

The L6386AD integrates a comparator (inverting input internally referenced to 0.5 V) that can be used to protect the device against fault events, like overcurrent. The DIAG output is a diagnostic pin, driven by the comparator, and used to signal a fault event occurrence to the controlling device.

The bootstrap diode is integrated in the driver allowing a more compact and reliable solution.

The L6386AD device features the UVLO protection on both supply voltages (V_{CC} and V_{BOOT}) ensuring greater protection against voltage drops on the supply lines.

The device is available in a SO-14 package, in tube, and tape and reel packaging.

Contents L6386AD

Contents

| 1 | Bloc | k diagram |
|---|-----------|------------------------------------|
| 2 | Elec | trical data |
| | 2.1 | Absolute maximum ratings |
| | 2.2 | Thermal data4 |
| | 2.3 | Recommended operating conditions 4 |
| | 2.4 | Pin connection |
| 3 | Elec | trical characteristics6 |
| | 3.1 | AC operation 6 |
| | 3.2 | DC operation 6 |
| | 3.3 | Timing diagram |
| 4 | Boot | tstrap driver |
| | C_{BOC} | ot selection and charging |
| 5 | Турі | cal characteristic 10 |
| 6 | Pack | kage information |
| | 6.1 | SO-14 package information |
| 7 | Orde | er codes |
| 8 | Revi | sion history |



L6386AD **Block diagram**

Block diagram 1

BOOTSTRAP DRIVER V_{BOOT} 14 C_{BOOT} UV DETECTION UV DETECTION HVG DRIVER HVG R 13 s LEVEL SHIFTER HIN OUT TO LOAD 12 LOGIC LVG SD LVG DRIVER PGND 8 LIN DIAG VREF · 5 SGND 6 CIN

Figure 1. Block diagram

D97IN520Dv1

Electrical data L6386AD

2 Electrical data

2.1 Absolute maximum ratings

Table 1. Absolute maximum ratings

| Symbol | Parameter | Value | Unit |
|-----------------------|--|------------------------------|------|
| V _{OUT} | Output voltage | -3 to V _{BOOT} - 18 | V |
| V _{CC} | Supply voltage | - 0.3 to +18 | V |
| V _{BOOT} | Floating supply voltage | -1 to 618 | V |
| V _{hvg} | High-side gate output voltage | - 1 to V _{BOOT} | V |
| V _{Ivg} | Low-side gate output voltage | -0.3 to V _{CC} +0.3 | V |
| Vi | Logic input voltage | -0.3 to V _{CC} +0.3 | V |
| V_{DIAG} | Open drain forced voltage | -0.3 to V _{CC} +0.3 | V |
| V _{CIN} | Comparator input voltage | -0.3 to 10 V | V |
| dV _{out} /dt | Allowed output slew rate | 50 | V/ns |
| P _{tot} | Total power dissipation (T _J = 85 °C) | 750 | mW |
| T _j | Junction temperature | 150 | °C |
| T _{stg} | Storage temperature | -50 to 150 | °C |

2.2 Thermal data

Table 2. Thermal data

| Symbol | Parameter | SO-14 | Unit |
|---------------------|--|-------|------|
| R _{th(JA)} | Thermal resistance junction to ambient | 165 | °C/W |

2.3 Recommended operating conditions

Table 3. Recommended operating conditions

| Symbol | Pin | Parameter | Test condition | Min. | Тур. | Max. | Unit |
|--------------------------------|-----|-------------------------|-------------------------------------|------|------|------|------|
| V _{OUT} | 12 | Output voltage | | (1) | | 580 | V |
| V _{BS} ⁽²⁾ | 14 | Floating supply voltage | | (1) | | 17 | ٧ |
| f _{sw} | | Switching frequency | HVG, LVG load C _L = 1 nF | | | 400 | kHz |
| V _{CC} | 4 | Supply voltage | | | | 17 | V |
| T _J | | Junction temperature | | -45 | | 125 | °C |

^{1.} If the condition V_{BOOT} - V_{OUT} < 18 V is guaranteed, V_{OUT} can range from -3 to 580 V.



^{2.} $V_{BS} = V_{BOOT} - V_{OUT}$.

L6386AD Electrical data

2.4 Pin connection

Figure 2. Pin connection (top view)

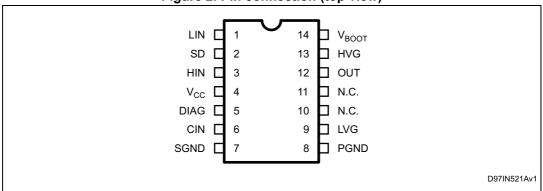


Table 4. Pin description

| No. | Pin | Туре | Function | |
|--------|--------------------|------|----------------------------------|--|
| 1 | LIN | I | Low-side driver logic input | |
| 2 | SD ⁽¹⁾ | I | Shutdown logic input | |
| 3 | HIN | I | High-side driver logic input | |
| 4 | V _{CC} | Р | Low voltage supply | |
| 5 | DIAG | 0 | Open drain diagnostic output | |
| 6 | CIN | I | Comparator input | |
| 7 | SGND | Р | Ground | |
| 8 | PGND | Р | Power ground | |
| 9 | LVG ⁽¹⁾ | 0 | Low-side driver output | |
| 10, 11 | N.C. | | Not connected | |
| 12 | OUT | Р | High-side driver floating driver | |
| 13 | HVG ⁽¹⁾ | 0 | High-side driver output | |
| 14 | V _{BOOT} | Р | Bootstrapped supply voltage | |

The circuit guarantees 0.3 V maximum on the pin (at I_{sink} = 10 mA), with V_{CC} > 3 V. This allows to omit the "bleeder" resistor connected between the gate and the source of the external MOSFET normally used to hold the pin low; the gate driver assures low impedance also in SD condition.

Electrical characteristics L6386AD

3 Electrical characteristics

3.1 AC operation

Table 5. AC operation electrical characteristics (V $_{CC}$ = 15 V; T $_{J}$ = 25 °C)

| Symbol | Pin | Parameter | Test condition | Min. | Тур. | Max. | Unit |
|------------------|----------------|---|--------------------------|------|------|------|------|
| t _{on} | 1, 3 vs. 9, 13 | High/low-side driver turn-on propagation delay | | | 110 | 150 | ns |
| t _{off} | 1, 3 vs. 9, 13 | High/low-side driver turn-off propagation delay | V _{OUT} = 0 V | | 110 | 150 | ns |
| t _{sd} | 2 vs. 9,13 | Shutdown to high/low-side propagation delay | | | 105 | 150 | |
| t _r | 9, 13 | Rise time | C _L = 1000 pF | | 50 | | ns |
| t _f | 9, 13 | Fall time | C _L = 1000 pF | | 30 | | ns |

3.2 DC operation

Table 6. DC operation electrical characteristics (V_{CC} = 15 V; T_J = 25 °C)

| Symbol | Pin | Parameter | Test condition | Min. | Тур. | Max. | Unit |
|---------------------|----------|---|---|------|------|------|------|
| Low supp | oly volt | age section | | | | | |
| V _{CCth1} | | V _{CC} UV turn-on threshold | | 9.1 | 9.6 | 10.1 | V |
| V _{CCth2} | | V _{CC} UV turn-off threshold | | 7.9 | 8.3 | 8.8 | V |
| V _{CChys} | 4 | V _{CC} UV hysteresis | | | 1.3 | | V |
| I _{QCCU} | · | Undervoltage quiescent supply current | V _{CC} ≤ 9 V | | 200 | | μА |
| I _{QCC} | | Quiescent current | V _{CC} = 15 V | | 250 | 320 | μА |
| Bootstra | pped su | upply section | | | | | |
| V _{BTh1} | | V _{BOOT} UV turn-on threshold | | 8.5 | 9.5 | 10.5 | V |
| V _{BTh2} | | V _{BOOT} UV turn-off threshold | | 7.2 | 8.2 | 9.2 | V |
| V _{BHys} | 14 | V _{BOOT} UV hysteresis | | | 1.3 | | V |
| I _{QBOOT} | | V _{BOOT} quiescent current | HVG ON | | | 200 | μА |
| I _{LK} | | High voltage leakage current | V _{hvg} = V _{OUT} = V _{BOOT} = 600 V | | | 10 | μА |
| R _{DS(on)} | | Bootstrap driver on-resistance ⁽¹⁾ | $V_{CC} \ge 12.5 \text{ V V}_{IN} = 0 \text{ V}$ | | 125 | | Ω |
| Driving b | uffers | section | | | | | |
| I _{so} | 9, 13 | High/low-side source short-circuit current | $V_{IN} = V_{ih} (t_p < 10 \ \mu s)$ | 300 | 400 | | mA |
| I _{si} | 9, 13 | High/low-side sink short-circuit current | $V_{IN} = V_{il} (t_p < 10 \ \mu s)$ | 500 | 650 | | mA |

| Symbol | Pin | Parameter | Test condition | Min | Тур | Max | Unit | |
|------------------|--------------|-------------------------------------|----------------------------|------|------|------|------|--|
| Logic inp | Logic inputs | | | | | | | |
| V _{il} | | Low level logic voltage | | | | 1.5 | V | |
| V _{ih} | 1, 2, 3 | High level logic voltage | | 3.6 | | | V | |
| I _{ih} | 1, 2, 3 | High level logic input current | V _{IN} = 15 V | | 50 | 70 | μА | |
| I _{il} | | Low level logic input current | V _{IN} = 0 V | | | 1 | μА | |
| Sense co | mparat | or | | | | | | |
| V _{io} | | Input offset voltage | | -10 | | 10 | mV | |
| I _{io} | 6 | Input bias current | $V_{CIN} \ge 0.5$ | | 0.2 | | μА | |
| V _{ol} | 2 | Open drain low level output voltage | $I_{od} = -2.5 \text{ mA}$ | | | 8.0 | V | |
| V _{ref} | | Comparator reference voltage | | 0.46 | 0.50 | 0.54 | V | |

Table 6. DC operation electrical characteristics (continued) (V_{CC} = 15 V; T_J = 25 $^{\circ}$ C)

$$R_{DSON} = \frac{(V_{CC} - V_{BOOT1}) - (V_{CC} - V_{BOOT2})}{I_1(V_{CC}, V_{BOOT1}) - I_2(V_{CC}, V_{BOOT2})}$$

where I_1 is the pin 14 current when $V_{BOOT} = V_{BOOT1}$, I_2 when $V_{BOOT} = V_{BOOT2}$.

Timing diagram 3.3

Figure 3. Input/output timing diagram⁽¹⁾ HIN LIN SD HOUT LOUT $V_{\text{CIN}} \\$ DIAG D97IN522Av1

^{1.} $R_{DS(on)}$ is tested in the following way:

If the SD is set low, each output remains in the shutdown condition also after the rising edge of the SD, until the first rising edge of the input signal occurs.

Bootstrap driver L6386AD

4 Bootstrap driver

A bootstrap circuitry is needed to supply the high voltage section. This function is normally accomplished by a high voltage fast recovery diode (*Figure 4* a). In the L6386AD device a patented integrated structure replaces the external diode. It is realized by a high voltage DMOS, driven synchronously with the low-side driver (LVG), with a diode in series, as shown in *Figure 4* b. An internal charge pump (*Figure 4* b) provides the DMOS driving voltage. The diode connected in series to the DMOS has been added to avoid undesirable turn-on.

CBOOT selection and charging

To choose the proper C_{BOOT} value, the external MOSFET can be seen as an equivalent capacitor. This capacitor C_{EXT} is related to the MOSFET total gate charge:

Equation 1

$$C_{EXT} = \frac{Q_{gate}}{V_{gate}}$$

The ratio between the capacitors C_{EXT} and C_{BOOT} is proportional to the cyclical voltage loss. It has to be:

E.g.: if Q_{gate} is 30 nC and V_{gate} is 10 V, C_{EXT} is 3 nF. With C_{BOOT} = 100 nF the drop would be 300 mV.

If HVG has to be supplied for a long time, the C_{BOOT} selection has to take into account also the leakage losses.

E.g.: HVG steady state consumption is lower than 200 μ A, so if HVG T_{ON} is 5 ms, C_{BOOT} has to supply 1 μ C to C_{EXT}. This charge on a 1 μ F capacitor means a voltage drop of 1 V.

The internal bootstrap driver gives great advantages: the external fast recovery diode can be avoided (it usually has a great leakage current).

This structure can work only if V_{OUT} is close to GND (or lower) and in the meanwhile the LVG is on. The charging time (T_{charge}) of the C_{BOOT} is the time in which both conditions are fulfilled and it has to be long enough to charge the capacitor.

The bootstrap driver introduces a voltage drop due to the DMOS $R_{DS(on)}$ (typical value: 125 Ω). At low frequency this drop can be neglected. Anyway increasing the frequency it must be taken into account.

The following equation is useful to compute the drop on the bootstrap DMOS:

Equation 2

$$V_{drop} = I_{charge}R_{dson} \rightarrow V_{drop} = \frac{Q_{gate}}{T_{charge}}R_{dson}$$

where Qgate is the gate charge of the external power MOSFET, R_{dson} is the on-resistance of the bootstrap DMOS, and T_{charge} is the charging time of the bootstrap capacitor.

8/17 DocID14914 Rev 3

L6386AD Bootstrap driver

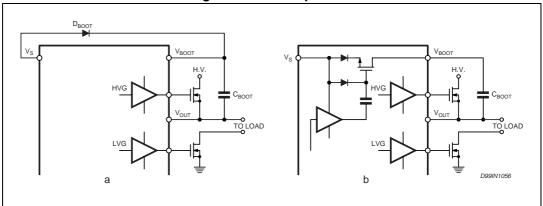
For example: using a power MOSFET with a total gate charge of 30 nC, the drop on the bootstrap DMOS is about 1 V, if the T_{charge} is 5 ms. In fact:

Equation 3

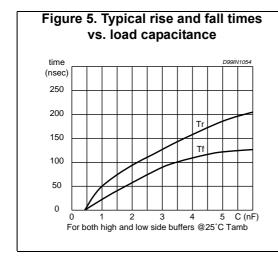
$$V_{drop} = \frac{30nC}{5\mu s} \cdot 125\Omega \sim 0.8V$$

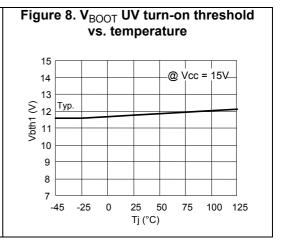
 V_{drop} has to be taken into account when the voltage drop on C_{BOOT} is calculated: if this drop is too high, or the circuit topology doesn't allow a sufficient charging time, an external diode can be used.

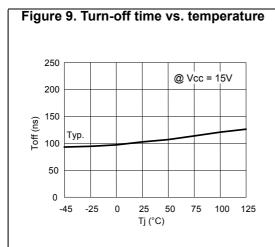
Figure 4. Bootstrap driver

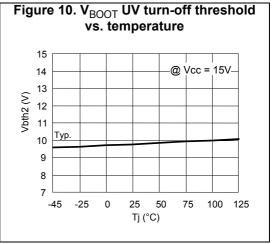


5 Typical characteristic









10/17 DocID14914 Rev 3

Figure 11. Shutdown time vs. temperature

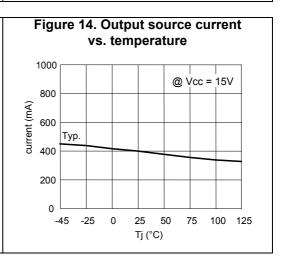
250
200
200
150
Typ.
50
-45 -25 0 25 50 75 100 125
Tj (°C)

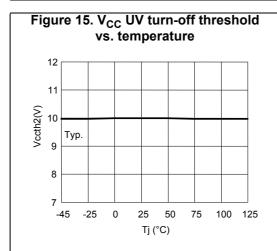
Figure 12. V_{BOOT} UV hysteresis

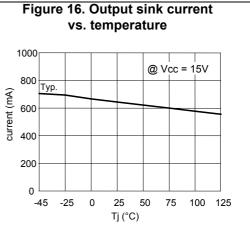
3
2.5
Typ.

1
-45 -25 0 25 50 75 100 125
Tj (°C)

Figure 13. V_{CC} UV turn-on threshold vs. temperature 15 14 13 Vccth1(V) 12 11 10 -45 -25 0 25 50 75 100 125 Tj (°C)

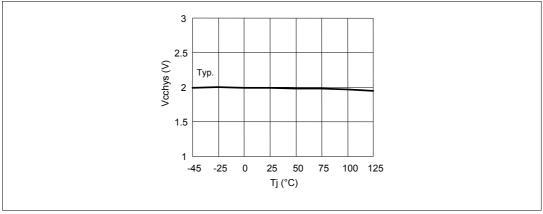






Typical characteristic L6386AD

Figure 17. V_{CC} UV hysteresis vs. temperature



L6386AD Package information

6 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.



Package information L6386AD

6.1 SO-14 package information

Figure 18. SO-14 package outline

Table 7. SO-14 package mechanical data

| | Table 7. 30-14 package mechanical data | | | | | | | |
|------------------|--|------|--------------|-------------------|-------|-------|--|--|
| Cumbal | Dimensions (mm) | | | Dimensions (inch) | | | | |
| Symbol | Min. | Тур. | Max. | Min. | Тур. | Max. | | |
| Α | 1.35 | | 1.75 | 0.053 | | 0.069 | | |
| A1 | 0.10 | | 0.30 | 0.004 | | 0.012 | | |
| A2 | 1.10 | | 1.65 | 0.043 | | 0.065 | | |
| В | 0.33 | | 0.51 | 0.013 | | 0.020 | | |
| С | 0.19 | | 0.25 | 0.007 | | 0.01 | | |
| D ⁽¹⁾ | 8.55 | | 8.75 | 0.337 | | 0.344 | | |
| E | 3.80 | | 4.0 | 0.150 | | 0.157 | | |
| е | | 1.27 | | | 0.050 | | | |
| Н | 5.8 | | 6.20 | 0.228 | | 0.244 | | |
| h | 0.25 | | 0.50 | 0.01 | | 0.02 | | |
| L | 0.40 | | 1.27 | 0.016 | | 0.050 | | |
| k | | | 0° (min.), 8 | s° (max.) | | • | | |
| ddd | | | 0.10 | | | 0.004 | | |

^{1. &}quot;D" dimension does not include mold flash, protrusions or gate burrs. Mold flash, protrusions or gate burrs shall not exceed 0.15 mm per side.



L6386AD Order codes

7 Order codes

Table 8. Device summary

| Order codes | Package | Packaging |
|--------------|---------|---------------|
| L6386AD | SO-14 | Tube |
| L6386AD013TR | SO-14 | Tape and reel |

Revision history L6386AD

8 Revision history

Table 9. Document revision history

| Date | Revision | Changes |
|-------------|----------|---|
| 14-Jul-2008 | 1 | First release |
| 20-Jun-2014 | 2 | Added Section: Applications on page 1. Updated Section: Description on page 1 (replaced by new description). Updated Table 1: Device summary on page 1 (moved "Table 9 Order codes" from page 15 to page 1, renamed title of Table 1). Updated Figure 1: Block diagram on page 3 (moved to page 3, added Section 1: Block diagram on page 3). Updated Section 2.1: Absolute maximum ratings on page 4 (removed note below Table 1: Absolute maximum ratings). Updated Table 4: Pin description on page 5 (updated "Type" of several pins). Numbered Equation 1 on page 8, Equation 2 on page 8 and Equation 3 on page 9. Updated Section 6: Package information on page 13 (updated ECOPACK text, updated/added titles, reversed order of Figure 18 and Table 7 (numbered Table 7), removed 3D package figure, minor modifications]. Minor modifications throughout document. |
| 29-Mar-2016 | 3 | Updated Section: Description on page 1 (updated text and replaced "power MOS" by "power MOSFET"). Updated Table 1 on page 4, Table 3 on page 4, Table 4 on page 5 to Table 6 on page 6 (updated "Symbol", "Parameter", "Pin", and "Test condition", and note 1. below Table 6 (replaced "V _{CBOOTx} " by "V _{BOOTx} "). Updated Figure 3 on page 7 (replaced by new figure, added note 1.). Moved Table 8 on page 15 (moved from page 1 to page 15, added title of Section 7: Order codes on page 15). Minor modifications throughout document. |

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